PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the Conveying Party Data previously recorded on Reel 028785 Frame 0613. Assignor(s) hereby confirms the assignment.

CONVEYING PARTY DATA

Name	Execution Date
Minseok S. KIM	07/23/2012
Sun-soo KIM	07/23/2012
Jin-hoon KIM	07/23/2012
Won-ho LEE	07/23/2012
Jeong-gun LEE	07/23/2012
Tae-seok SIM	07/23/2012
Sang-hyun BAEK	07/23/2012
Hyo-young JEONG	07/23/2012

RECEIVING PARTY DATA

Name:	Samsung Electronics Co., Ltd.	
Street Address:	129, Samsung-ro, Yeongtong-gu	
City:	Suwon-si, Gyeonggi-do	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	443-742	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13584552

CORRESPONDENCE DATA

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REEL: 030488 FRAME: 0788

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ATTORNEY DOCKET NUMBER:	709918
NAME OF SUBMITTER:	John L. Gase
Signature:	/John L. Gase/
Date:	05/24/2013
Total Attachments: 3 source=Assignment#page1.tif source=Assignment#page2.tif source=Assignment#page3.tif	

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ASSIGNMENT

WHEREAS, I/WE

Minseok S. KIM, Sun-soo KIM, Jin-hoon KIM, Won-ho LEE, Jeong-gun LEE, Tae-seok SIM, Sang-hyun BAEK, Hyo-young JEONG, all c/o Samsung Advanced Institute of Technology, San 14-1 Nongseo-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea

hereinafter referred to as Assignor, have invented a certain invention entitled:

FLUID CONTROLLING APPARATUS AND FILTER AND BIOCHIP INCLUDING THE FLUID CONTROLLING APPARATUS

for which invention an application (provisional or non-provisional) for a U.S. patent was filed on August 13, 2012, under U.S. Application No. 13/584.552, and

WHEREAS, SAMSUNG ELECTRONICS CO., LTD. of 416 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, hereinafter referred to as Assignee, is desirous of acquiring the entire right, title, and interest in, to, and under the invention described in the patent application, including the entire priority right derived from the application,

Now, Therefore, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged,

Assignor assigns and transfers to Assignee and Assignee's legal representatives, successors, and assigns the entire right, title, and interest in, to, and under the invention, the referenced patent application, and other such applications (e.g., provisional applications, non-provisional applications, continuations, continuations-in-part, divisionals, reissues, reexaminations, national and regional phase applications, petty patent applications, and utility model applications) that may be filed in the U.S. and/or any country foreign to the U.S. on the invention, and the patents that may issue thereon,

Assignor conveys to the Assignee the right to make applications in Assignee's own behalf for protection of the invention in the U.S. and countries foreign to the U.S. and to claim priority to the referenced patent application and other such applications that may be filed in the U.S. or any country foreign to the U.S. on the invention under the Patent Cooperation Treaty, the Paris Convention, and any other international arrangements,

Assignor will not execute any writing or do any act conflicting with the terms of this assignment,

Assignor will at any time upon request, without further or additional consideration, but at the expense of the Assignee, execute such additional assignments and other writings and do such additional acts as the Assignee may deem necessary or desirable to pursue the patent applications identified herein, including, but not limited to, rendering all necessary assistance in making applications for and obtaining patents that may issue thereon in the U.S. and any

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countries foreign to the U.S. on the invention, and in enforcing any rights accruing as a result of such applications or patents, by, for example, executing statements and other affidavits,

Assignor and Assignee agree the terms of this assignment shall bind, and inure to the benefit of, the legal representatives, successors, and assigns of all parties hereto,

Assignor authorizes Assignee to insert in this assignment the number and filing date of the application if the number and filing date of the application are not recited herein at the time of execution of this assignment by any or all of the parties hereto,

Assignor and Assignee agree that U.S. law governs this assignment, and

Assignee acknowledges and accepts this assignment.

IN WITNESS WHEREOF, Assignor has hereunder set his/her hand on the date shown below.

Date	July 23, 2012	Assignor: Minseok S. KIM
Date	July 23, 2012	
Date	July 23, 2012	Assignor: Jin-hoon KIM
		Assignor: Jin-noon Kim
Date	July 23, 2012	Assignor: Won-ho LEE
Date	July 23, 2012	Assignor: Jeong-gun LEE

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In re Appln. of KIM et al.		Attorney Docket No. 709918 Client Reference No. SI-39680-US / RG2011060021US0	
Date	July 23, 2012		
		Assignor: Tae-seok SIM	
Date	July 23, 2012	Assignor: Sang-hyun BAEK	
	*	======================================	
Date July 23, 2012	July 23, 2012	Assignor: Hyo-young JEONG	

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RECORDED: 05/24/2013

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